

# Innovating Energy Technology

www.fujielectric.com/products/semiconductor/ Automotive **FUJI POWER MOSFET** 

# N-Channel enhancement mode power MOSFET

#### Features

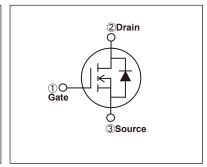
Low on-state resistance Low switching loss Easy to use (more controllable switching dV/dt by Rg) The reliability trial conforms to AEC Q101. 100% avalanche tested

#### Applications

Automotive switching applications

# TO-247 23 (1)Gate (2)Drain (3)Source

# Equivalent circuit schematic



## Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	<i>V</i> <sub>GS</sub> =-30V
Continuous Drain Current	1	±22.8	А	Tc=25°C Note*1
Continuous Drain Current	<i>I</i> D	±14.4	А	Tc=100°C Note*1
Pulsed Drain Current	1 <sub>DP</sub>	±68.2	А	Note *1
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Non-Repetitive Maximum Avalanche Current	las	3.5	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	748	mJ	Note *3
Maximum Drain-Source dV/dt	dV <sub>DS</sub> /dt	50	kV/µs	<i>V</i> <sub>DS</sub> ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Dawar Disaination	P	2.5	W	<i>T</i> <sub>a</sub> =25°C
Maximum Power Dissipation	PD	140	vv	<i>T</i> c=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to +150	°C	

Note \*1 : Limited by maximum channel temperature. Note \*2 :  $T_{ch} \le 150^{\circ}$ C, See Fig.1 and Fig.2 Note \*3 : Starting  $T_{ch}$ =25°C, /as=2.1A, L=311mH, /v\_D=25V,  $R_G$ =50 $\Omega$ , See Fig.1 and Fig.2  $E_{AS}$  limited by maximum channel temperature and avalanche current. Note \*4 : /sp  $\le$  -/p, d//dt=10A/µs, /v\_S peak  $\le$  600V,  $T_{ch} \le$  150°C. Note \*5 : /sp  $\le$  -/p, dV/dt=15kV/µs, /v\_S peak  $\le$  600V,  $T_{ch} \le$  150°C.

# Electrical Characteristics at *T*c=25°C (unless otherwise specified) • Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I₀=250µA		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =1.22mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	Ioss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	2	μA
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	<i>T</i> <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>DS</sub> =0V V <sub>GS</sub> =±30V		-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V I <sub>D</sub> =11.4A		-	0.110	0.125	Ω
Gate resistance	RG	f=1MHz, open drain		-	8.3	-	Ω

# Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> =25V I <sub>D</sub> =11.4A	7.5	15	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =400V	-	1240	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	42	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	6.3	-	
Effective output capacitance, energy related (Note *6)	Co(er)	V <sub>GS</sub> =0V V <sub>DS</sub> =0400V	-	102	-	pF
Effective output capacitance, time related (Note *7)	Co(tr)	V <sub>GS</sub> =0V V <sub>DS</sub> =0400V I₀=constant	-	391	-	
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V / <sub>D</sub> =11.4A, R <sub>G</sub> =15Ω See Fig.3 and Fig.4	-	21	-	- ns
Turn-On Time	tr		-	78	-	
Turn-Off Time	t <sub>d(off)</sub>		-	101	-	
Turn-Off Time	ti		-	24	-	
Total Gate Charge	QG		-	53	-	
Gate-Source Charge	Q <sub>GS</sub>	$V_{DD}$ =400V, /b=22.8A	-	20	-	nC
Gate-Drain Charge	QGD	─ V <sub>es</sub> =10V _ See Fig.5	-	20	-	
Drain-Source crossover Charge	Qsw		-	13	-	

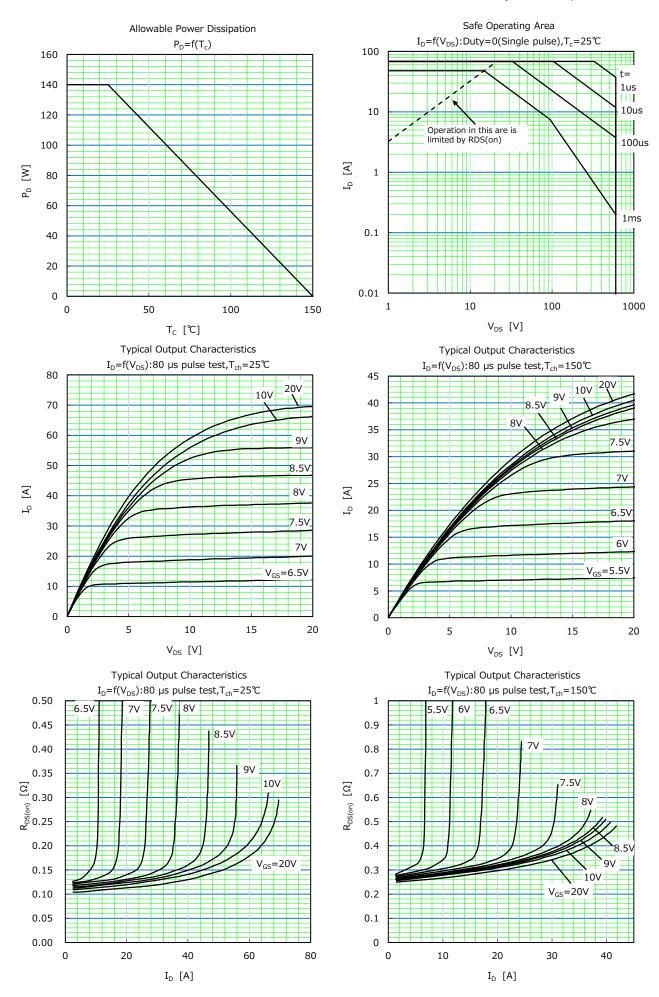
Note \*6 :  $C_{0(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V. Note \*7 :  $C_{0(er)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V.

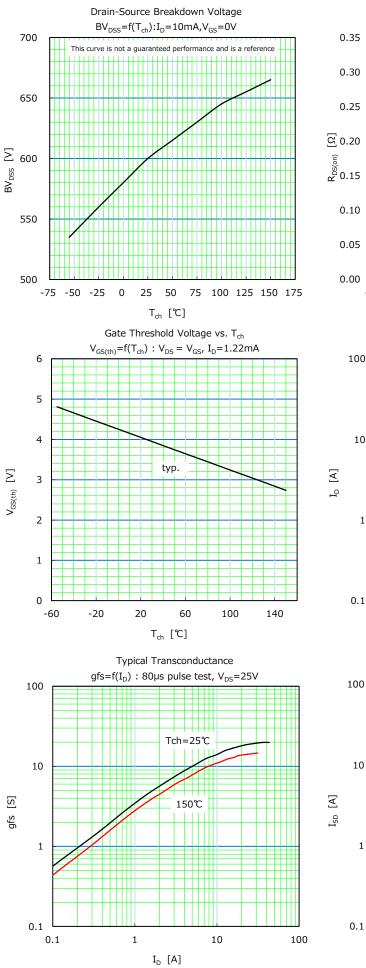
# Reverse Diode Ratings

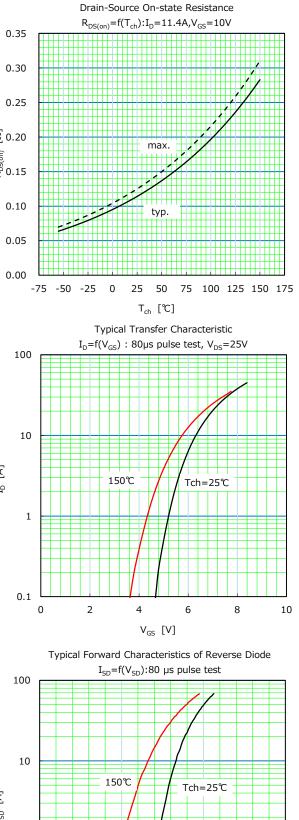
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Diode Forward On-Voltage	Vsd	I <sub>SD</sub> =22.8A, V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	0.90	1.35	V
Reverse Recovery Time	trr	- V <sub>DD</sub> =400V, / <sub>SD</sub> =22.8A -di/dt=100A/μs 7 <sub>ch</sub> =25°C See Fig.6 and Fig.7	-	310	-	ns
Reverse Recovery Charge	Qrr		-	4.4	-	μC
Peak Reverse Recovery Current	Irp		-	27	-	А

## Thermal Characteristics

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.888	°C/W
Channel to Ambient	Rth(ch-a)	-	-	50	°C/W







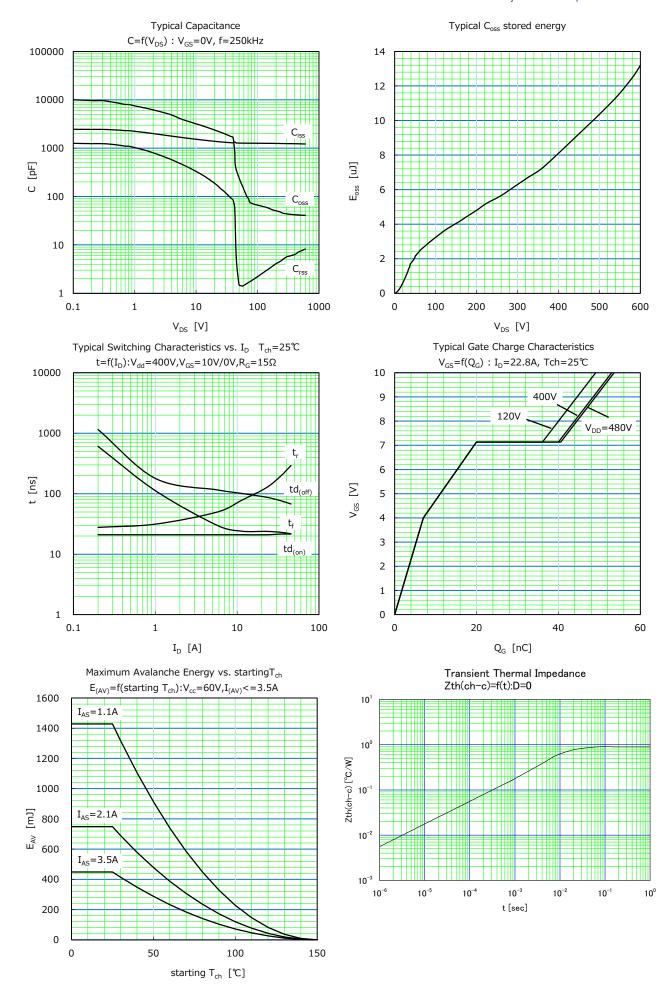
0

0.5

 $V_{SD}$  [V]

1

1.5



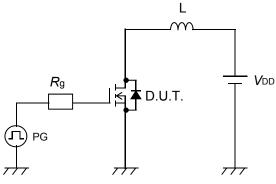
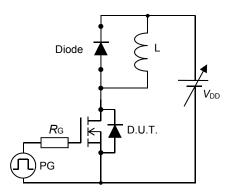


Fig.1 Avalanche Test circuit



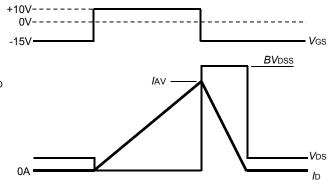


Fig.2 Operating waveforms of Avalanche Test

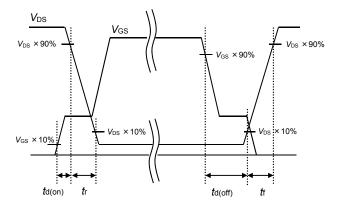


Fig.4 Operating waveform of Switching Test

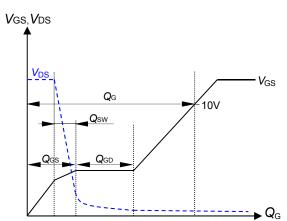
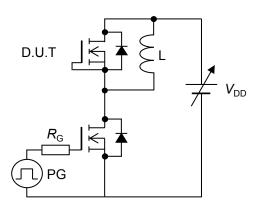
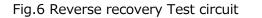


Fig.3 Switching Test circuit

Fig.5 Operating waveform of Gate charge Test





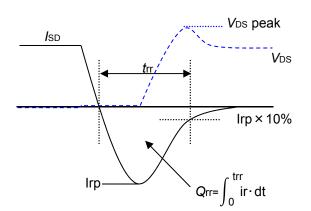
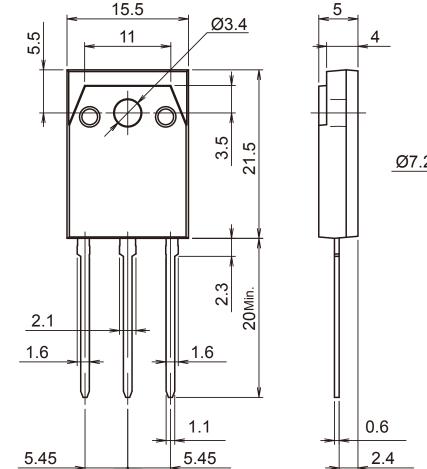


Fig.7 Operating waveform of Reverse recovery Test

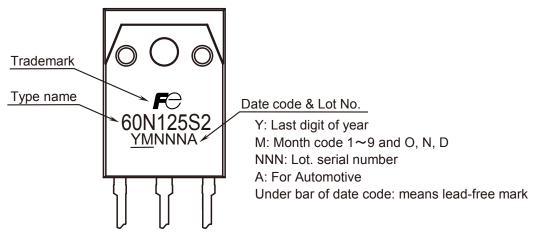
6

# Outview: TO-247 (Type: A) Package



DIMENSIONS ARE IN MILLIMETERS.

# Marking



\* The font (font type,size) and the trademark size might be acutually different.

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